BAS16QA-Q

High-speed switching diode

14 April 2023 **Product data sheet**

1. General description

Single high-speed switching diode encapsulated in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

2. Features and benefits

- High switching speed: $t_{rr} \leq 4$ ns
- Low leakage current: $I_R \leq 0.5$ µA
- Reverse voltage $V_R \leq 100$ V
- Low capacitance $C_d \leq 1.5$ pF
- Ultra small SMD plastic package
- Low package height of 0.37 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- High-speed switching
- General-purpose switching

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I_F	forward current	T_{amb} = 25 °C	[1]	-	-	290	mA
V_R	reverse voltage	T_j = 25 °C		-	-	100	V
V_F	forward voltage	I_F = 150 mA; T_j = 25 °C		-	-	1.25	V
I_R	reverse current	V_R = 80 V; T_j = 25 °C		-	-	0.5	µA
t_{rr}	reverse recovery time	I_F = 10 mA; I_R = 10 mA; $I_{R(meas)}$ = 1 mA; R_L = 100 Ω; T_j = 25 °C		-	-	4	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

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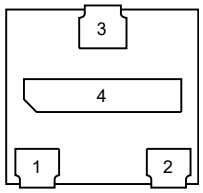
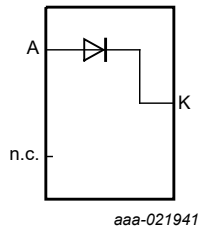
5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode	 Transparent top view **DFN1010D-3 (SOT1215)**	 *aaa-021941*
2	n.c.	not connected		
3	K	cathode		
4	K	cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAS16QA-Q	DFN1010D-3	plastic, leadless thermal enhanced ultra thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.75 mm pitch; 1.1 mm x 1 mm x 0.37 mm body	SOT1215

7. Marking

Table 4. Marking codes

Type number	Marking code
BAS16QA-Q	Z 101

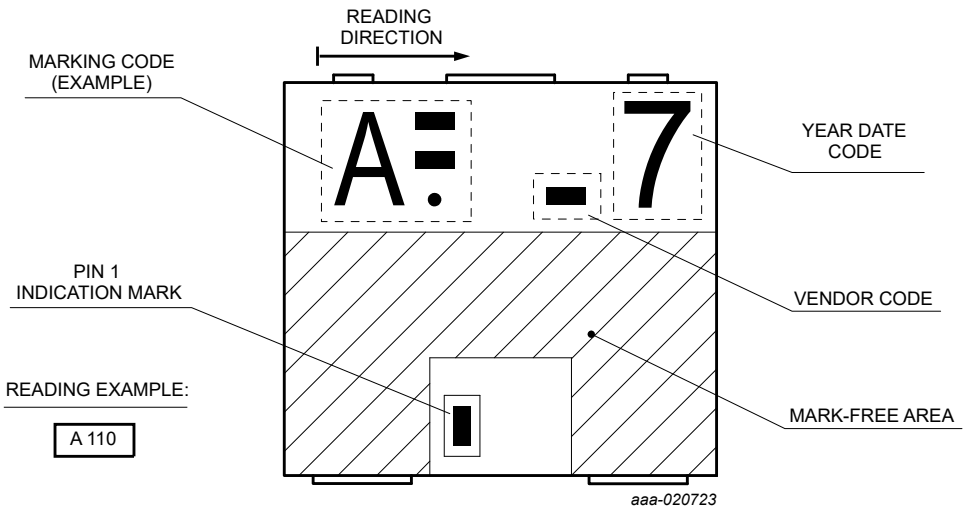


Fig. 1. DFN1010D-3 (SOT1215) binary marking code description

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T_j = 25 °C		-	100	V
I_F	forward current	T_{amb} = 25 °C	[1]	-	290	mA
I_{FRM}	repetitive peak forward current	$t_p \leq$ 0.5 ms; $\delta \leq$ 0.25		-	700	mA
I_{FSM}	non-repetitive peak forward current	t_p = 100 µs; square wave; $T_{j(init)}$ = 25 °C		-	4	A
		t_p = 1 ms; square wave; $T_{j(init)}$ = 25 °C		-	1.5	A
		t_p = 1 s; square wave; $T_{j(init)}$ = 25 °C		-	0.5	A
P_{tot}	total power dissipation	$T_{amb} \leq$ 25 °C	[1]	-	305	mW
			[2]	-	470	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

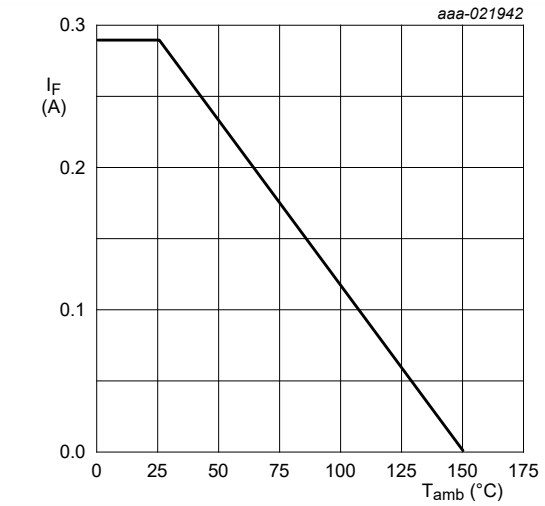


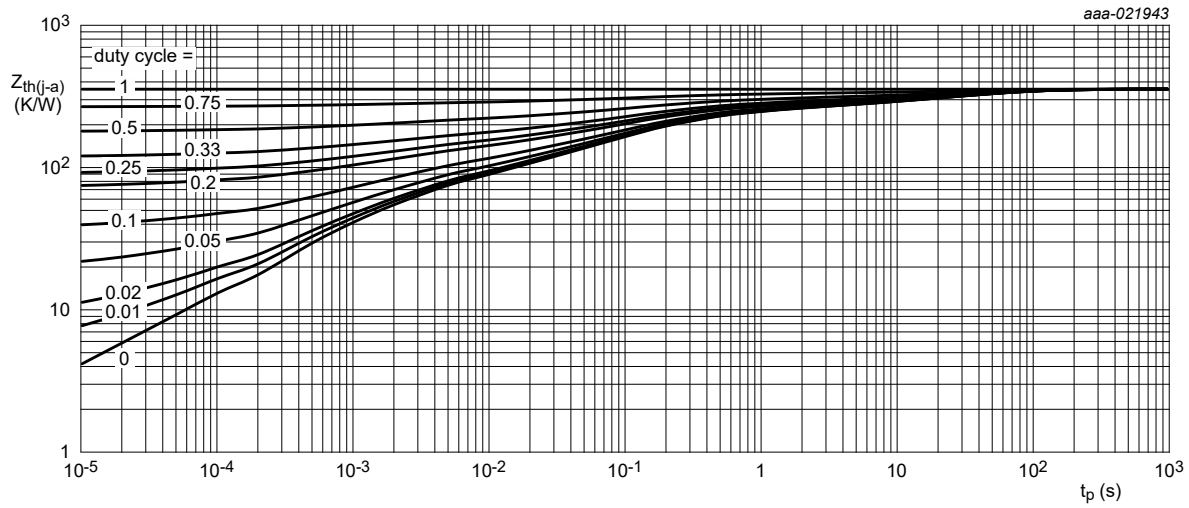
Fig. 2. Forward current as a function of ambient temperature; derating curve

9. Thermal characteristics

Table 6. Thermal characteristics

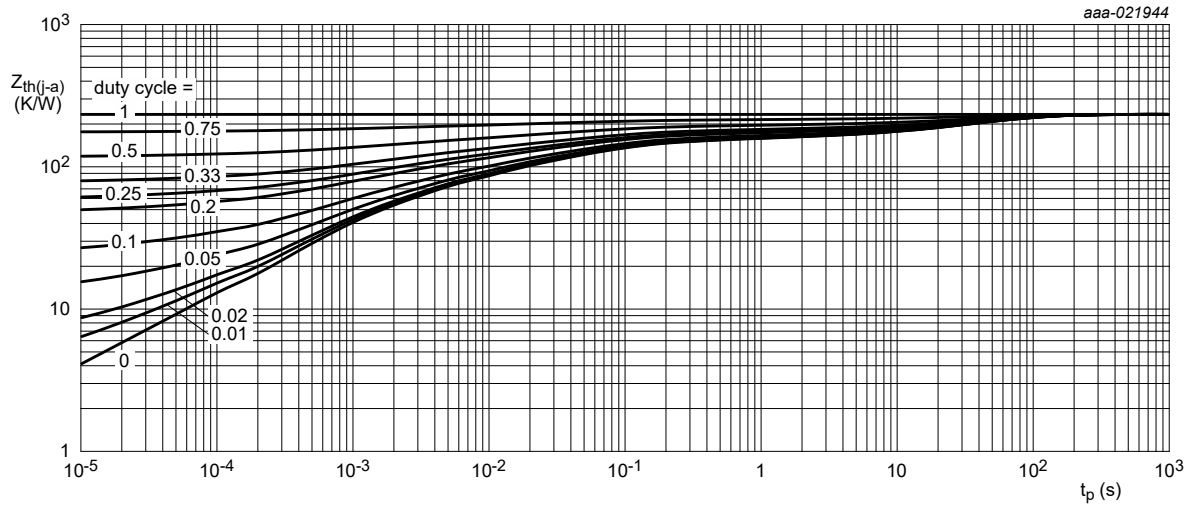
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	410	K/W
			[2]	-	-	265	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	55	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
[3] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



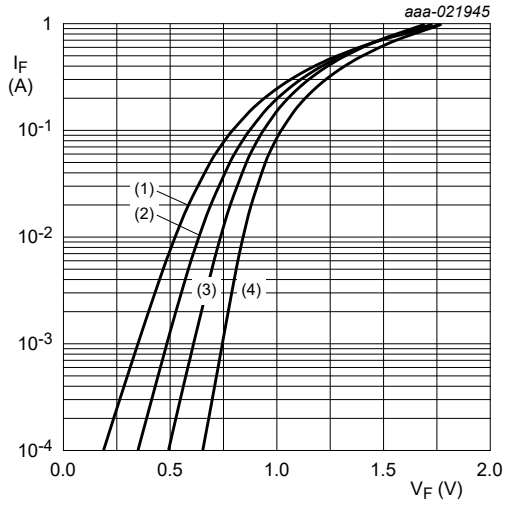
FR4 PCB, mounting pad for cathode 1 cm²

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

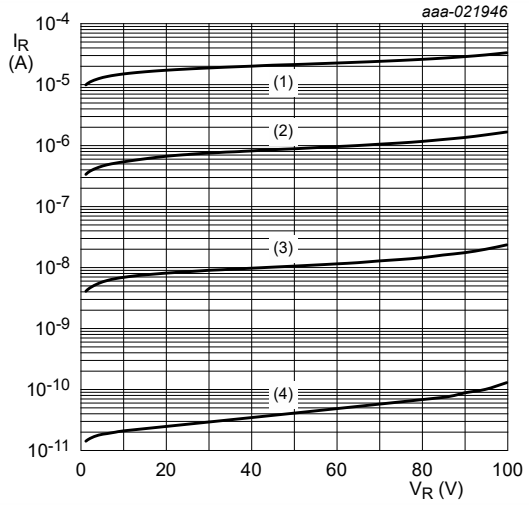
Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_F	forward voltage	I_F = 1 mA; T_j = 25 °C		-	-	715	mV
		I_F = 10 mA; T_j = 25 °C		-	-	855	mV
		I_F = 50 mA; T_j = 25 °C		-	-	1	V
		I_F = 150 mA; T_j = 25 °C		-	-	1.25	V
I_R	reverse current	V_R = 25 V; T_j = 25 °C		-	-	30	nA
		V_R = 80 V; T_j = 25 °C		-	-	0.5	µA
		V_R = 25 V; T_j = 150 °C		-	-	30	µA
		V_R = 80 V; T_j = 150 °C		-	-	50	µA
C_d	diode capacitance	V_R = 0 V; f = 1 MHz; T_j = 25 °C		-	-	1.5	pF
t_{rr}	reverse recovery time	I_F = 10 mA; I_R = 10 mA; $I_{R(meas)}$ = 1 mA; R_L = 100 Ω; T_j = 25 °C		-	-	4	ns
V_{FRM}	peak forward recovery voltage	I_F = 10 mA; T_j = 25 °C; t_r = 20 ns		-	-	1.75	V



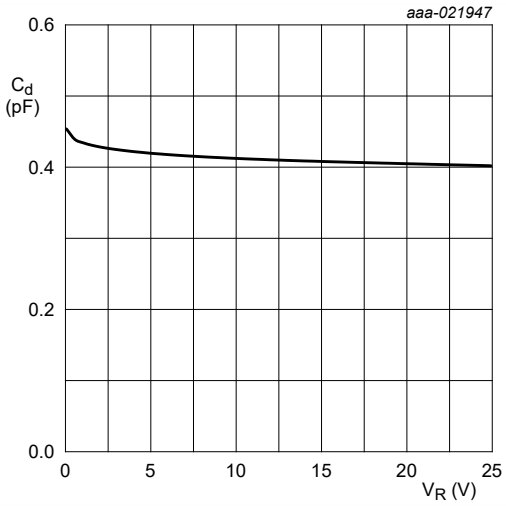
(1) T_j = 150 °C
(2) T_j = 85 °C
(3) T_j = 25 °C
(4) T_j = −40 °C

Fig. 5. Forward current as a function of forward voltage; typical values



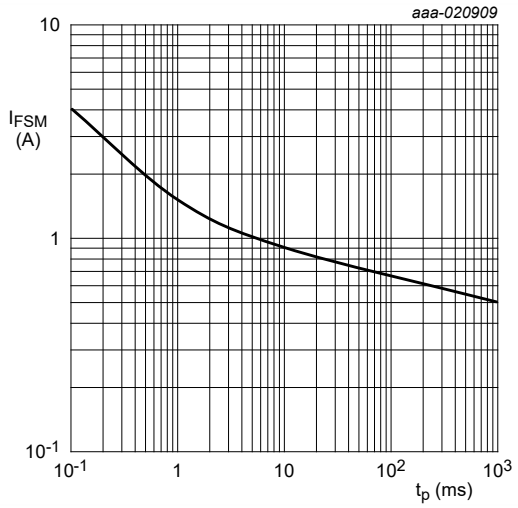
(1) T_j = 150 °C
(2) T_j = 85 °C
(3) T_j = 25 °C
(4) T_j = −40 °C

Fig. 6. Reverse current as a function of reverse voltage; typical values



f = 1MHz; T_{amb} = 25 °C

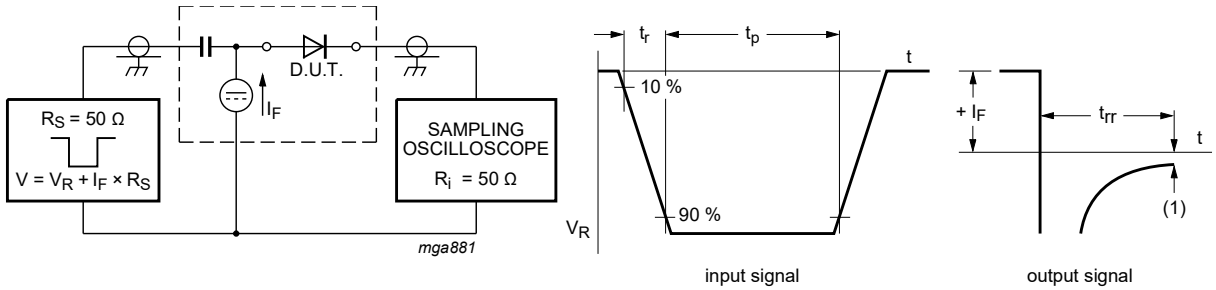
Fig. 7. Diode capacitance as a function of reverse voltage; typical values



Based on square wave currents.
T_{amb} = 25 °C

Fig. 8. Non-repetitive forward current as a function of pulse duration; maximum values

11. Test information



(1) I_R = 1 mA

Fig. 9. Reverse recovery time test circuit and waveforms

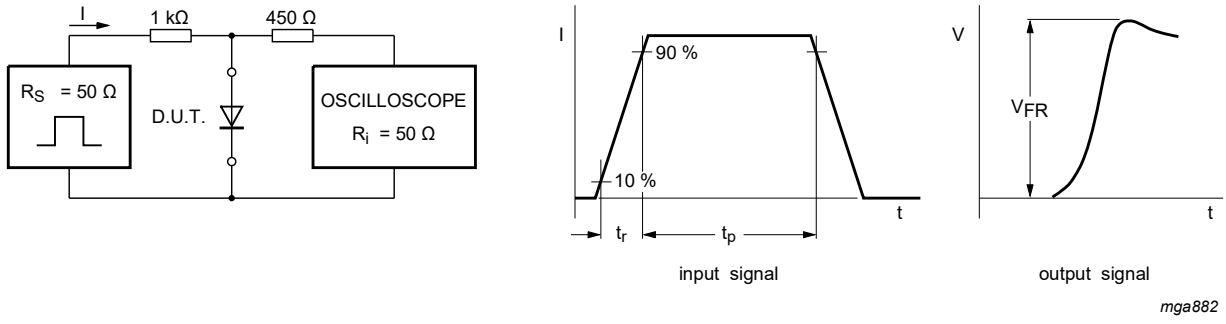


Fig. 10. Forward recovery voltage test circuit and waveforms

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

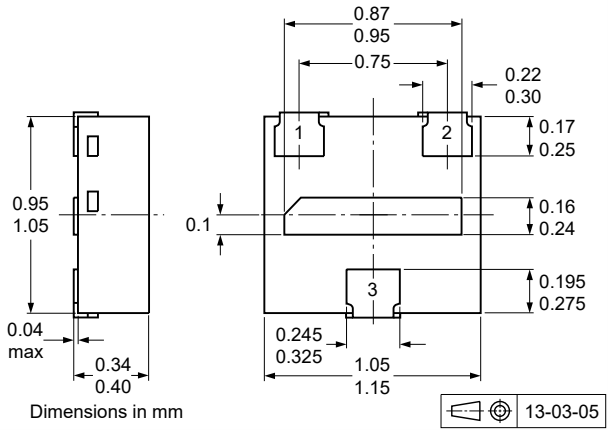


Fig. 11. Package outline DFN1010D-3 (SOT1215)

13. Soldering

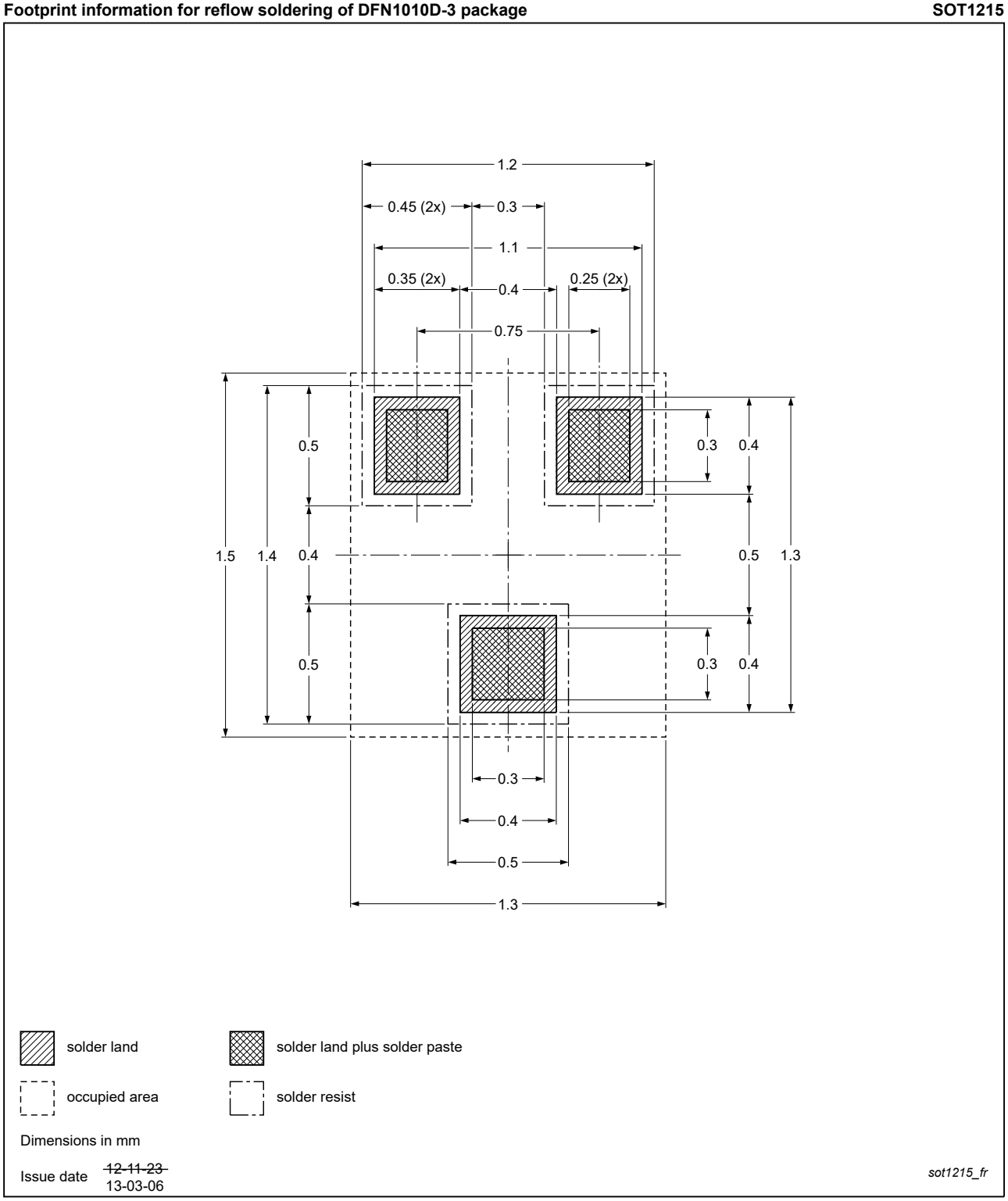


Fig. 12. Reflow soldering footprint for DFN1010D-3 (SOT1215)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS16QA-Q v.1	20230414	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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